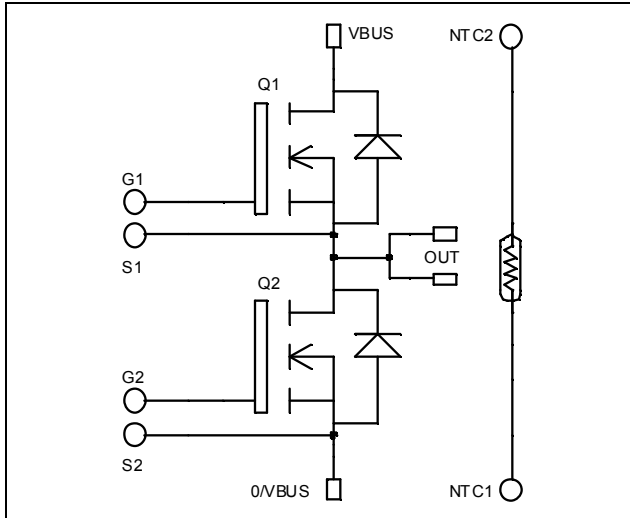


## Phase leg MOSFET Power Module

$V_{DSS} = 1000V$   
 $R_{DSon} = 180m\Omega$  typ @  $T_j = 25^\circ C$   
 $I_D = 43A$  @  $T_c = 25^\circ C$

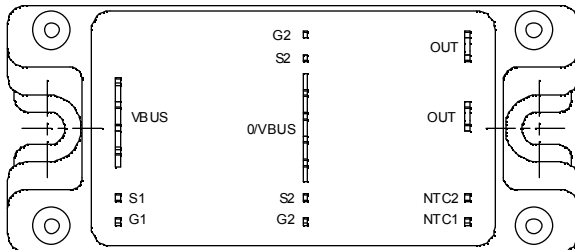


### Application

- Welding converters
- Switched Mode Power Supplies
- Uninterruptible Power Supplies
- Motor control

### Features

- Power MOS 7<sup>®</sup> FREDFETs
  - Low  $R_{DSon}$
  - Low input and Miller capacitance
  - Low gate charge
  - Fast intrinsic reverse diode
  - Avalanche energy rated
  - Very rugged
- Kelvin source for easy drive
- Very low stray inductance
  - Symmetrical design
  - Lead frames for power connections
- Internal thermistor for temperature monitoring
- High level of integration




### Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- RoHS compliant

### Absolute maximum ratings

Symbol	Parameter	Max ratings	Unit
$V_{DSS}$	Drain - Source Breakdown Voltage	1000	V
$I_D$	Continuous Drain Current	$T_c = 25^\circ C$	43
		$T_c = 80^\circ C$	33
$I_{DM}$	Pulsed Drain current	172	A
$V_{GS}$	Gate - Source Voltage	$\pm 30$	V
$R_{DSon}$	Drain - Source ON Resistance	210	$m\Omega$
$P_D$	Maximum Power Dissipation	$T_c = 25^\circ C$	780
$I_{AR}$	Avalanche current (repetitive and non repetitive)	25	A
$E_{AR}$	Repetitive Avalanche Energy	50	mJ
$E_{AS}$	Single Pulse Avalanche Energy	3000	


**CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on [www.microsemi.com](http://www.microsemi.com)

All ratings @  $T_j = 25^\circ\text{C}$  unless otherwise specified

**Electrical Characteristics**

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{GS} = 0\text{V}, V_{DS} = 1000\text{V}$			200	$\mu\text{A}$
		$V_{GS} = 0\text{V}, V_{DS} = 800\text{V}$			1000	
$R_{DS(on)}$	Drain – Source on Resistance	$V_{GS} = 10\text{V}, I_D = 21.5\text{A}$		180	210	$\text{m}\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 5\text{mA}$	3		5	V
$I_{GSS}$	Gate – Source Leakage Current	$V_{GS} = \pm 30\text{V}, V_{DS} = 0\text{V}$			$\pm 150$	nA

**Dynamic Characteristics**

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
$C_{iss}$	Input Capacitance	$V_{GS} = 0\text{V}$		10.4		nF
$C_{oss}$	Output Capacitance	$V_{DS} = 25\text{V}$		1.76		
$C_{rss}$	Reverse Transfer Capacitance	$f = 1\text{MHz}$		0.32		
$Q_g$	Total gate Charge	$V_{GS} = 10\text{V}$		372		nC
$Q_{gs}$	Gate – Source Charge	$V_{Bus} = 500\text{V}$		48		
$Q_{gd}$	Gate – Drain Charge	$I_D = 43\text{A}$		244		
$T_{d(on)}$	Turn-on Delay Time	<b>Inductive switching @ 125°C</b> $V_{GS} = 15\text{V}$ $V_{Bus} = 670\text{V}$ $I_D = 43\text{A}$ $R_G = 2.5\Omega$		18		ns
$T_r$	Rise Time			12		
$T_{d(off)}$	Turn-off Delay Time			155		
$T_f$	Fall Time			40		
$E_{on}$	Turn-on Switching Energy	<b>Inductive switching @ 25°C</b> $V_{GS} = 15\text{V}, V_{Bus} = 670\text{V}$ $I_D = 43\text{A}, R_G = 2.5\Omega$		1800		$\mu\text{J}$
$E_{off}$	Turn-off Switching Energy			1246		
$E_{on}$	Turn-on Switching Energy	<b>Inductive switching @ 125°C</b> $V_{GS} = 15\text{V}, V_{Bus} = 670\text{V}$ $I_D = 43\text{A}, R_G = 2.5\Omega$		2846		$\mu\text{J}$
$E_{off}$	Turn-off Switching Energy			1558		

**Source - Drain diode ratings and characteristics**

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit	
$I_S$	Continuous Source current (Body diode)	$T_c = 25^\circ\text{C}$			43	A	
		$T_c = 80^\circ\text{C}$			33		
$V_{SD}$	Diode Forward Voltage	$V_{GS} = 0\text{V}, I_S = -43\text{A}$			1.3	V	
$dv/dt$	Peak Diode Recovery <sup>①</sup>				18	V/ns	
$t_{rr}$	Reverse Recovery Time	$I_S = -43\text{A}$ $V_R = 670\text{V}$ $di/dt = 200\text{A}/\mu\text{s}$	$T_j = 25^\circ\text{C}$			320	ns
			$T_j = 125^\circ\text{C}$			650	
$Q_{rr}$	Reverse Recovery Charge	$I_S = -43\text{A}$ $V_R = 670\text{V}$ $di/dt = 200\text{A}/\mu\text{s}$	$T_j = 25^\circ\text{C}$		7.2	$\mu\text{C}$	
			$T_j = 125^\circ\text{C}$		19.5		

<sup>①</sup>  $dv/dt$  numbers reflect the limitations of the circuit rather than the device itself.

$$I_S \leq -43\text{A} \quad di/dt \leq 700\text{A}/\mu\text{s} \quad V_R \leq V_{DSS} \quad T_j \leq 150^\circ\text{C}$$

**Thermal and package characteristics**

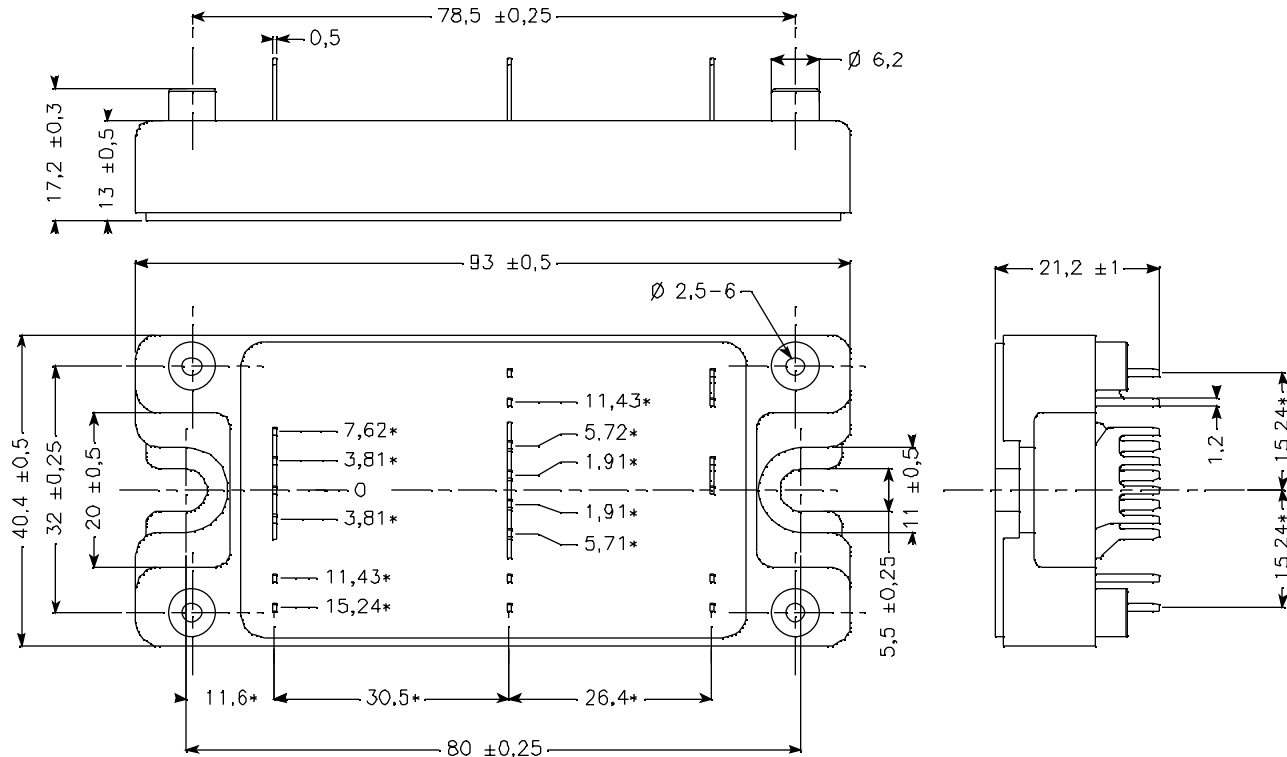
Symbol	Characteristic	Min	Typ	Max	Unit	
R <sub>thJC</sub>	Junction to Case Thermal resistance			0.16	°C/W	
V <sub>ISOL</sub>	RMS Isolation Voltage, any terminal to case t=1 min, I <sub>isol</sub> <1mA, 50/60Hz	2500			V	
T <sub>J</sub>	Operating junction temperature range	-40		150	°C	
T <sub>STG</sub>	Storage Temperature Range	-40		125		
T <sub>C</sub>	Operating Case Temperature	-40		100		
Torque	Mounting torque	To Heatsink	M5	2.5	4.7	N.m
Wt	Package Weight			160		g

**Temperature sensor NTC** (see application note APT0406 on www.microsemi.com for more information).

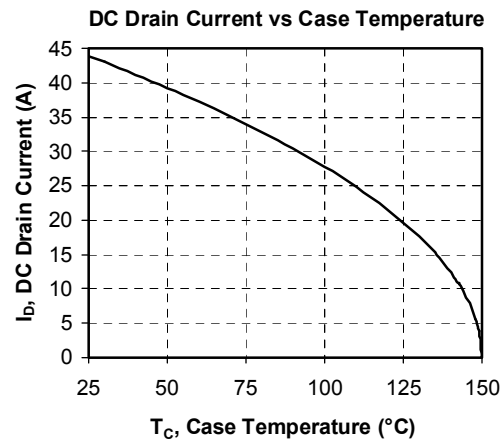
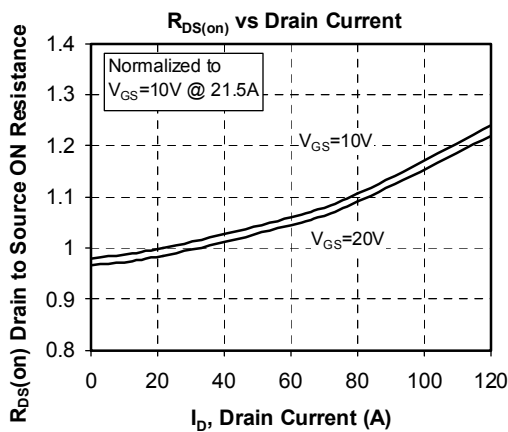
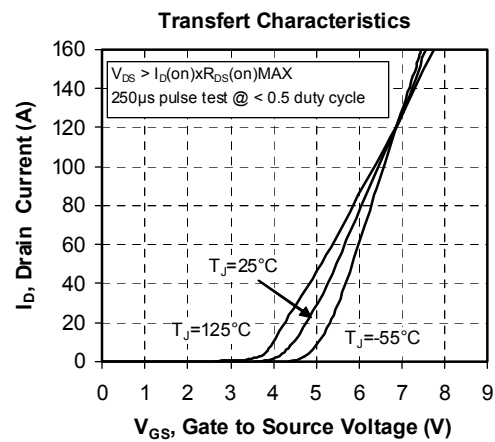
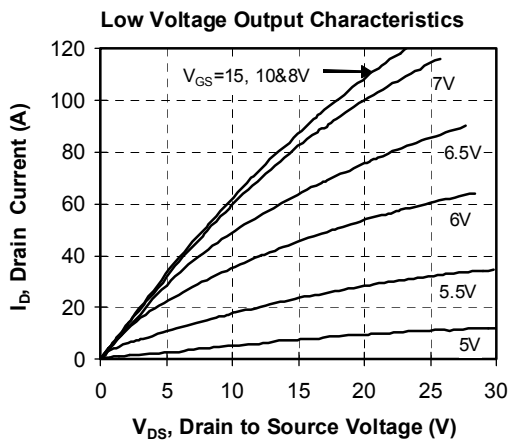
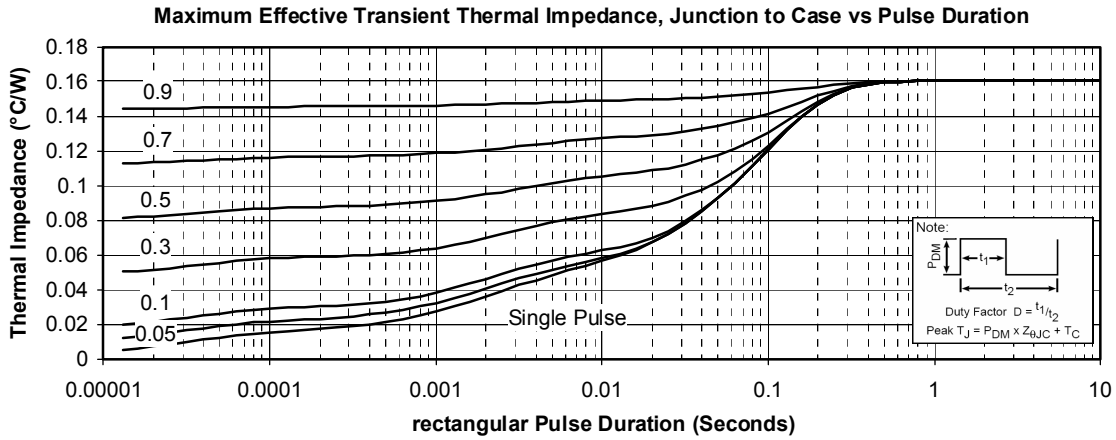
Symbol	Characteristic	Min	Typ	Max	Unit
R <sub>25</sub>	Resistance @ 25°C		50		kΩ
B <sub>25/85</sub>	T <sub>25</sub> = 298.15 K		3952		K

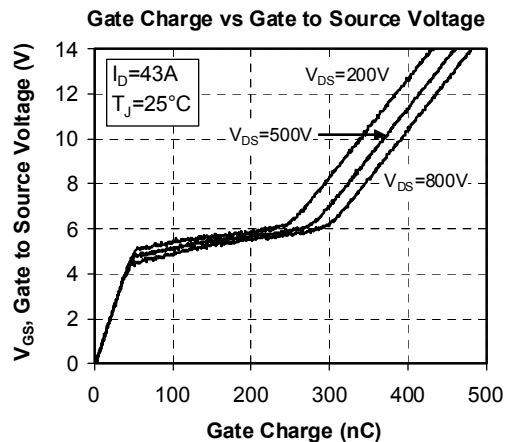
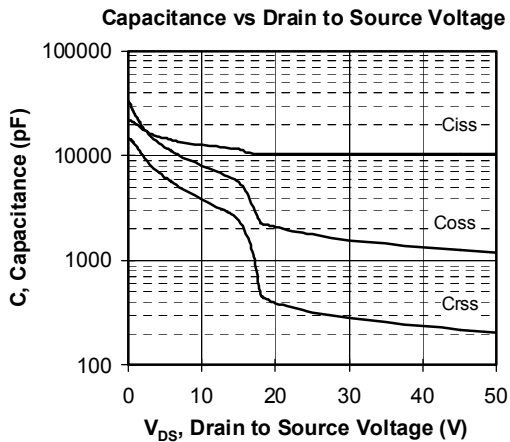
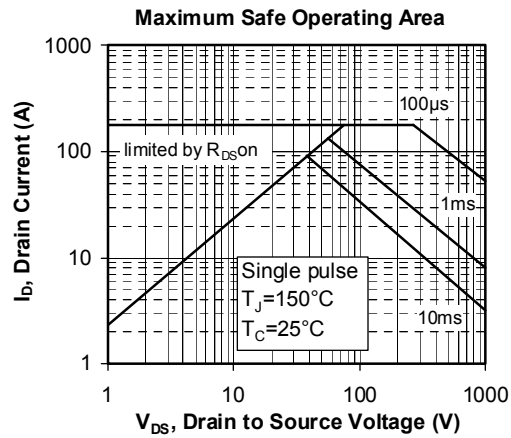
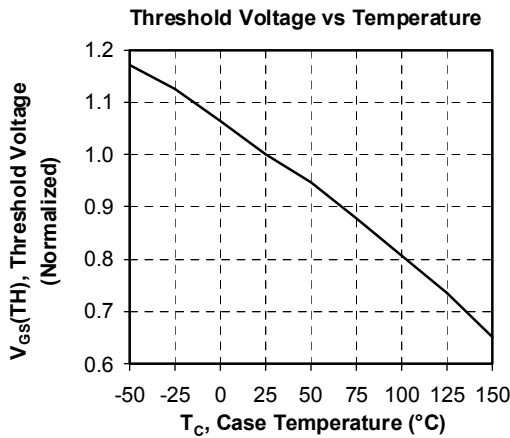
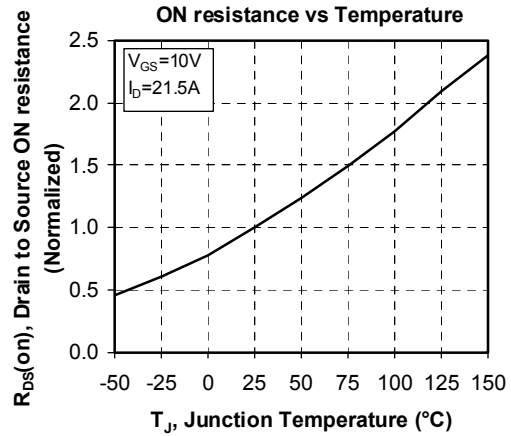
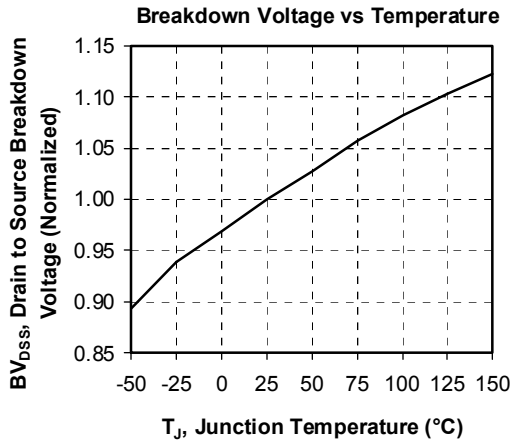
$$R_T = \frac{R_{25}}{\exp\left[B_{25/85}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]}$$

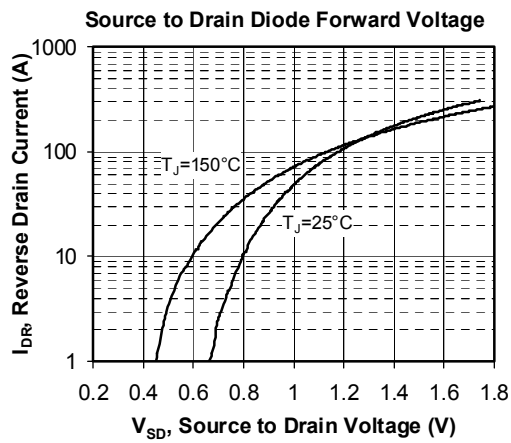
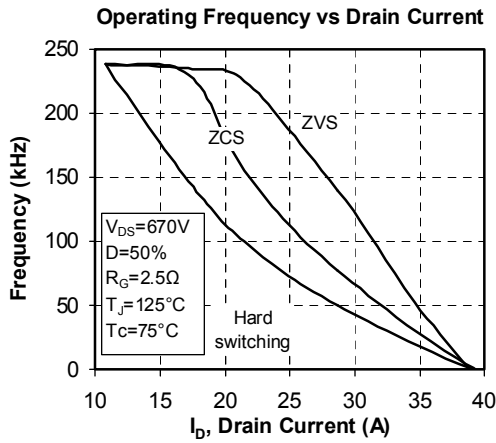
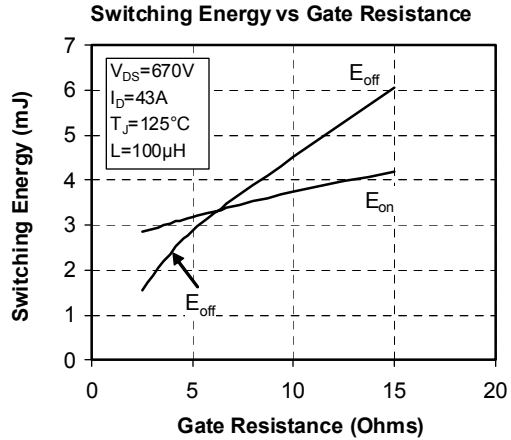
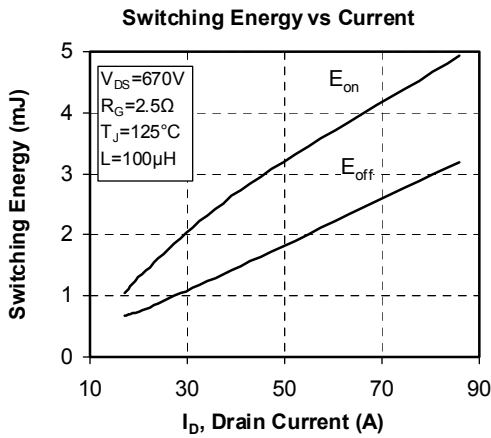
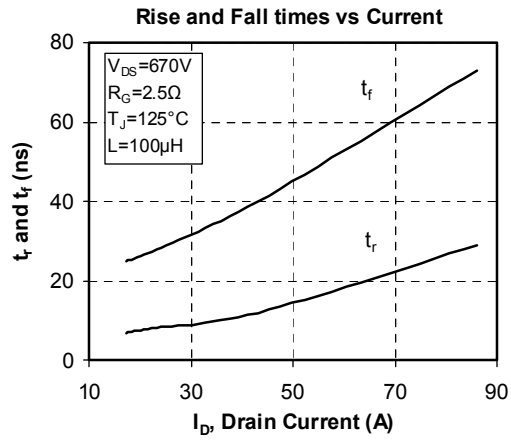
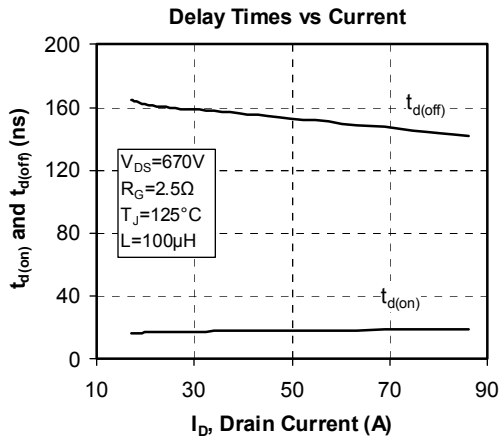
T: Thermistor temperature  
 R<sub>T</sub>: Thermistor value at T

**SP4 Package outline** (dimensions in mm)

 ALL DIMENSIONS MARKED "\*" ARE TOLERANCED AS:  $\text{M} \begin{matrix} \oplus \\ \ominus \end{matrix} 0.1$ 

See application note APT0501 - Mounting Instructions for SP4 Power Modules on www.microsemi.com

**Typical Performance Curve**






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